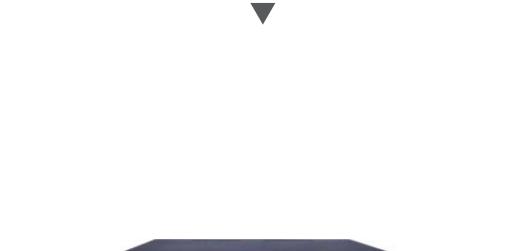
RAK-130S IDEAL FOR WALL-MOUNT RACKS OR CABINETS





1U SHORT-DEPTH RACKMOUNT SERVER PC WITH INTEL® COFFEE LAKE S-SERIES PROCESSORS

- > 2x DP, 1x HDMI for display output
- ► 3x GbE LAN for Ethernet
- ► 6x USB 3.1, 2x RS232/422/485 for peripheral connection
- > 2x 2.5" SATA 3.0 HDD / SSD support
- > 2x accessible PCIe x16 slot (x8 signal), 1x M.2 Key A, 1x M.2 Key B, 1x M.2 Key M

RAK-130S

1U SHORT-DEPTH RACKMOUNT SERVER WITH INTEL® COFFEE LAKE S-SERIES PROCESSORS

RAK-130S is a 1U rackmount server powered by Intel® Coffee Lake S-Series Processors. The short-depth design allows it to be installed in the space-saving wall-mount racks or cabinets.

The server features flexible network, storage and expansion

configuration, including three GbE LAN ports for flexibly allocate network resource, two 2.5" SATA 3.0 HDDs / SSDs support for storage, three M.2 sockets for SSD / WLAN / WWAN expansion, and two accessible PCle x16 slots (x8 signal support) for application-specific expansion.

Storage LED

PCIe x16 Card Slot (x8 signal)

► PRODUCT HIGHLIGHTS

- ► Intel® Coffee Lake S-Series Processors (LGA1151 Socket)
- ► Intel® C246 / Q370 Express Chipset
- 2x DDR4 U-DIMM memory socket (ECC support)
- 2x DP, 1x HDMI for video output
- ▶ 3x GbE LAN for Ethernet
- ► 6x USB 3.1, 2x USB 2.0 for USB device connection
- > 2x RS232/422/485 for serial device connection
- > 2x 2.5" SATA 3.0 HDD / SSD support
- ▶ 1x M.2 Key A for WLAN expansion
- ▶ 1x M.2 Key B for SSD / WWAN expansion
- ▶ 1x M.2 Key M for SSD storage
- > 2x accessible PCIe x16 (x8 signal) for application-specific expansion
- ▶ 1U short-depth rackmount design

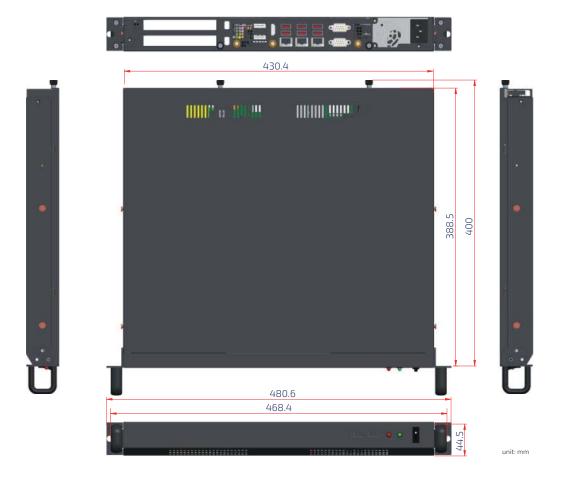


USB 3.1

DP

RS232/422/485

MECHANICAL DIMENSIONS



AC-IN

► TECHNICAL INFORMATION

SYSTEM	PROCESSOR CHIPSET MEMORY	Intel® Coffee Lake-S Core™ i CPUs (LGA1151 socket) Intel® Coffee Lake-S Xeon® E CPUs (LGA1151 socket) Intel® C246 (Xeon® E & Core™ i CPU) Intel® Q370 (Core™ i CPU) 2x DDR4 2400/2666 U-DIMM memory socket (ECC support)
VIDEO	GRAPHICS DISPLAY INTERFACE MULTIPLE DISPLAY	Intel® UHD Graphics P630 (Xeon® E CPU) Intel® UHD Graphics 630 (Core™ i CPU) 2x DP (on rear, 4096 x 2304 @ 60 Hz) 1x HDMI 1.4 (on rear, 4096 x 2160 @ 24 Hz / 2560 x 1600 @ 60 Hz) Triple
NETWORK CONNECTION	ETHERNET	3x GbE LAN (RJ45 on rear, 1x Intel® I219-LM, 1x Intel® I210-AT, 1x Intel® I211-AT)
PERIPHERAL CONNECTION	USB SERIAL PORT	6x USB 3.1 (Type A on rear) 2x USB 2.0 (Type A n front) 2x RS232/422/485 (DB9 on rear)
STORAGE & EXPANSION		2x 2.5" SATA 3.0 HDD / SSD 1x M.2 Key M (type 2280, mixed w/ PCIe x4) 1x M.2 Key A (type 2230, mixed w/ PCIe x1 & USB 2.0) 1x M.2 Key B (type 2242, mixed w/ PCIe x1, SATA 3.0 & USB 3.1) 2x PCIe x16 Slot (x8 signal, accessible on rear) 1x SIM Card Cage (by cable, optional)
POWER	CONNECTOR INPUT VOLTAGE	C14 AC Power Connector (on rear) AC 100 V ~ 240 V
FIRMWARE	BIOS WATCHDOG H/W MONITOR REAL TIME CLOCK TPM	AMI uEFI BIOS w/ 128 Mb SPI Flash Programmable WDT to generate system reset event Input & Core Voltages, CPU & System Temperatures Chipset integrated RTC Supported (Infineon SLB 9665 TPM 2.0)
SYSTEM CONTROL & MONITORING	BUTTON, SWITCH & INDICATOR	1x Power Switch (on front) 1x Power LED (on front) 1x Storage LED (on front)
COOLING	COOLING METHOD	Active
SOFTWARE	OS SUPPORT	Windows 10 (Core™ i CPU) Windows Server (Xeon® E CPU) Linux (Core™ i CPU)
MECHANICAL	CONSTRUCTION DIMENSIONS (W × D × H) WEIGHT MOUNTING	1U Metal Rackmount Chassis 430.4 mm × 400 mm × 44.5 mm / 16.94" × 15.75" × 1.75" (without handles) 480.6 mm × 439 mm × 44.5 mm / 18.92" × 17.28" × 1.75" (with handles) TBD Rackmount
ENVIRONMENTAL	OPERATION TEMPERATURE STORAGE TEMPERATURE HUMIDITY	0 °C ~ 40 °C / 32 °F ~ 104 °F -20 °C ~ 80 °C / -4 °F ~ 176 °F 0 % ~ 95 %
CERTIFICATION	EMC & SAFETY	CE, FCC Class B